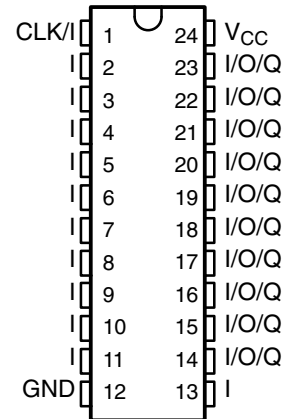


# TIBPAL22V10C, TIBPAL22V10AC, TIBPAL22V10AM HIGH-PERFORMANCE *IMPACT*™ PROGRAMMABLE ARRAY LOGIC CIRCUITS

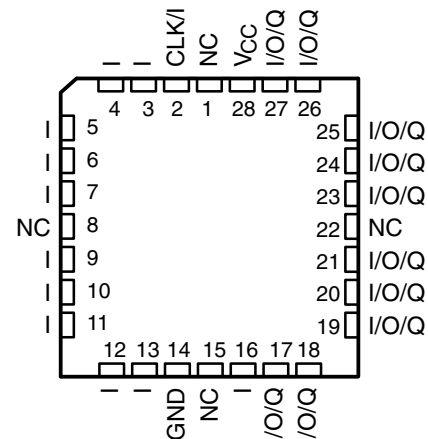
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- **Second-Generation PLD Architecture**
- **Choice of Operating Speeds**  
TIBPAL22V10AC . . . 25 ns Max  
TIBPAL22V10AM . . . 30 ns Max  
TIBPAL22V10C . . . 35 ns Max
- **Increased Logic Power – Up to 22 Inputs and 10 Outputs**
- **Increased Product Terms – Average of 12 Per Output**
- **Variable Product Term Distribution Allows More Complex Functions to Be Implemented**
- **Each Output Is User Programmable for Registered or Combinational Operation, Polarity, and Output Enable Control**
- **TTL-Level Preload for Improved Testability**
- **Extra Terms Provide Logical Synchronous Set and Asynchronous Reset Capability**
- **Fast Programming, High Programming Yield, and Unsurpassed Reliability Ensured Using Ti-W Fuses**
- **AC and DC Testing Done at the Factory Utilizing Special Designed-In Test Features**
- **Dependable Texas Instruments Quality and Reliability**
- **Package Options Include Both Plastic and Ceramic Chip Carriers in Addition to Plastic and Ceramic DIPs**
- **Functionally Equivalent to AMDs AMPAL22V10 and AMPAL22V10A**

**C SUFFIX . . . NT PACKAGE**  
**M SUFFIX . . . JT OR W PACKAGE**  
**(TOP VIEW)**



**C SUFFIX . . . FN PACKAGE**  
**M SUFFIX . . . FK PACKAGE**  
**(TOP VIEW)**



NC – No internal connection  
Pin assignments in operating mode

## description

The TIBPAL22V10 and TIBPAL22V10A are programmable array logic devices featuring high speed and functional equivalency when compared to presently available devices. They are implemented with the familiar sum-of-products (AND-OR) logic structure featuring the new concept "Programmable Output Logic Macrocell". These *IMPACT*™ circuits combine the latest Advanced Low-Power Schottky technology with proven titanium-tungsten fuses to provide reliable, high-performance substitutes for conventional TTL logic.

These devices contain up to 22 inputs and 10 outputs. They incorporate the unique capability of defining and programming the architecture of each output on an individual basis. Outputs may be registered or nonregistered and inverting or noninverting as shown in the output logic macrocell diagram. The ten potential outputs are enabled through the use of individual product terms.

These devices are covered by U.S. Patent 4,410,987.  
*IMPACT* is a trademark of Texas Instruments Incorporated.

PRODUCTION DATA information is current as of publication date.  
Products conform to specifications per the terms of Texas Instruments  
standard warranty. Production processing does not necessarily include  
testing of all parameters.

**TEXAS  
INSTRUMENTS**

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**TIBPAL22V10C, TIBPAL22V10AC, TIBPAL22V10AM**  
**HIGH-PERFORMANCE *IMPACT*™ PROGRAMMABLE ARRAY LOGIC CIRCUITS**SRPS024A – OCTOBER 1986 – REVISED APRIL 2010

---

**description (continued)**

Further advantages can be seen in the introduction of variable product term distribution. This technique allocates from 8 to 16 logical product terms to each output for an average of 12 product terms per output. This variable allocation of terms allows far more complex functions to be implemented than in previously available devices.

Circuit design is enhanced by the addition of a synchronous set and an asynchronous reset product term. These functions are common to all registers. When the synchronous set product term is a logic 1, the output registers are loaded with a logic 1 on the next low-to-high clock transition. When the asynchronous reset product term is a logic 1, the output registers are loaded with a logic 0. The output logic level after set or reset depends on the polarity selected during programming. Output registers can be preloaded to any desired state during testing. Preloading permits full logical verification during product testing.

With features such as programmable output logic macrocells and variable product term distribution, the TIBPAL22V10 and TIBPAL22V10A offer quick design and development of custom LSI functions with complexities of 500 to 800 equivalent gates. Since each of the ten output pins may be individually configured as inputs on either a temporary or permanent basis, functions requiring up to 21 inputs and a single output or down to 12 inputs and 10 outputs are possible.

A power-up clear function is supplied that forces all registered outputs to a predetermined state after power is applied to the device. Registered outputs selected as active-low power up with their outputs high. Registered outputs selected as active-high power up with their outputs low.

A single security fuse is provided on each device to discourage unauthorized copying of fuse patterns. Once blown, the verification circuitry is disabled and all other fuses will appear to be open.

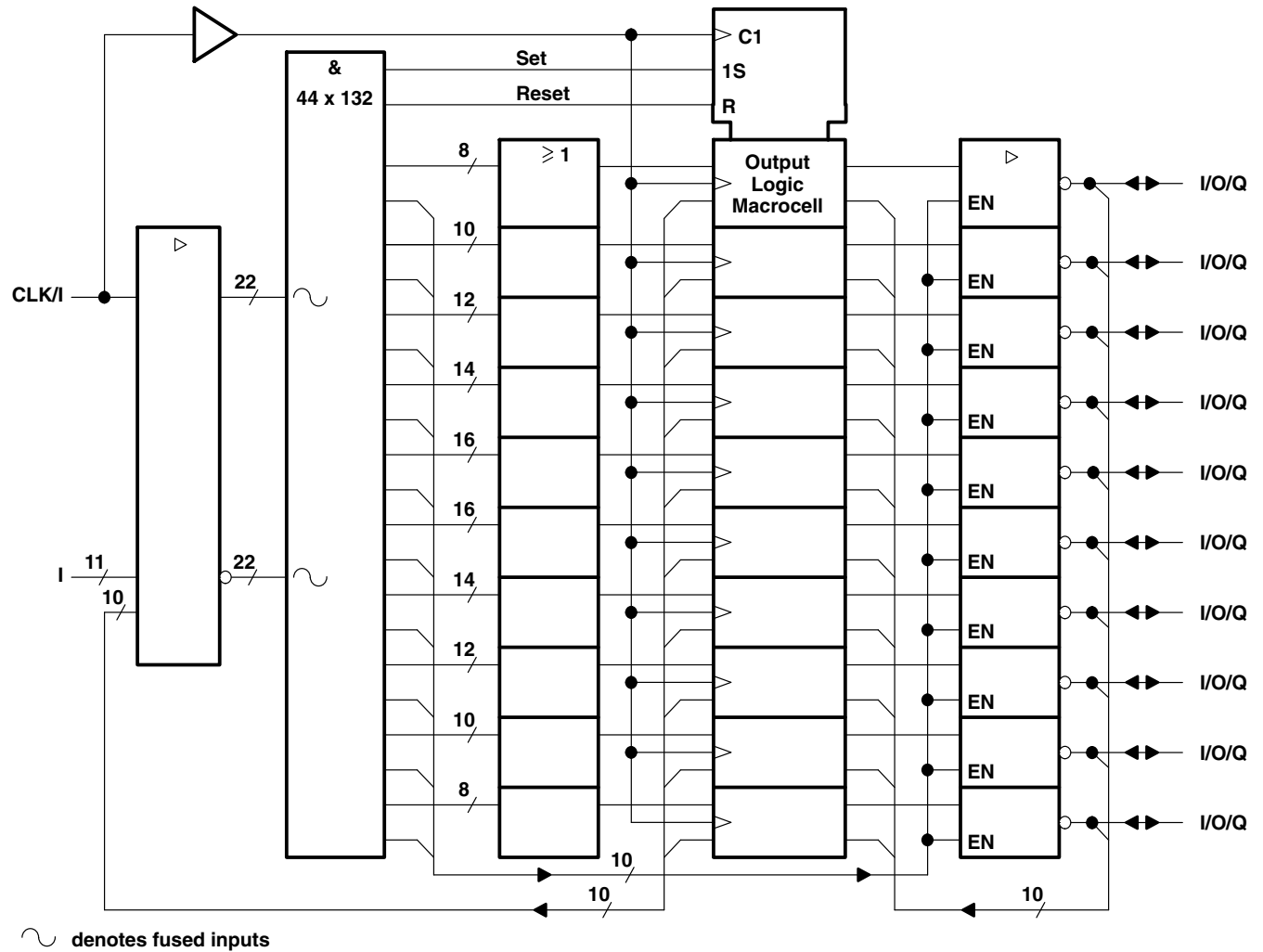
The TIBPAL22V10C and TIBPAL22V10AC are characterized for operation from 0°C to 75°C. The TIBPAL22V10AM is characterized for operation over the full military temperature range of –55°C to 125°C.



# TIBPAL22V10C, TIBPAL22V10AC, TIBPAL22V10AM HIGH-PERFORMANCE *IMPACT*™ PROGRAMMABLE ARRAY LOGIC CIRCUITS

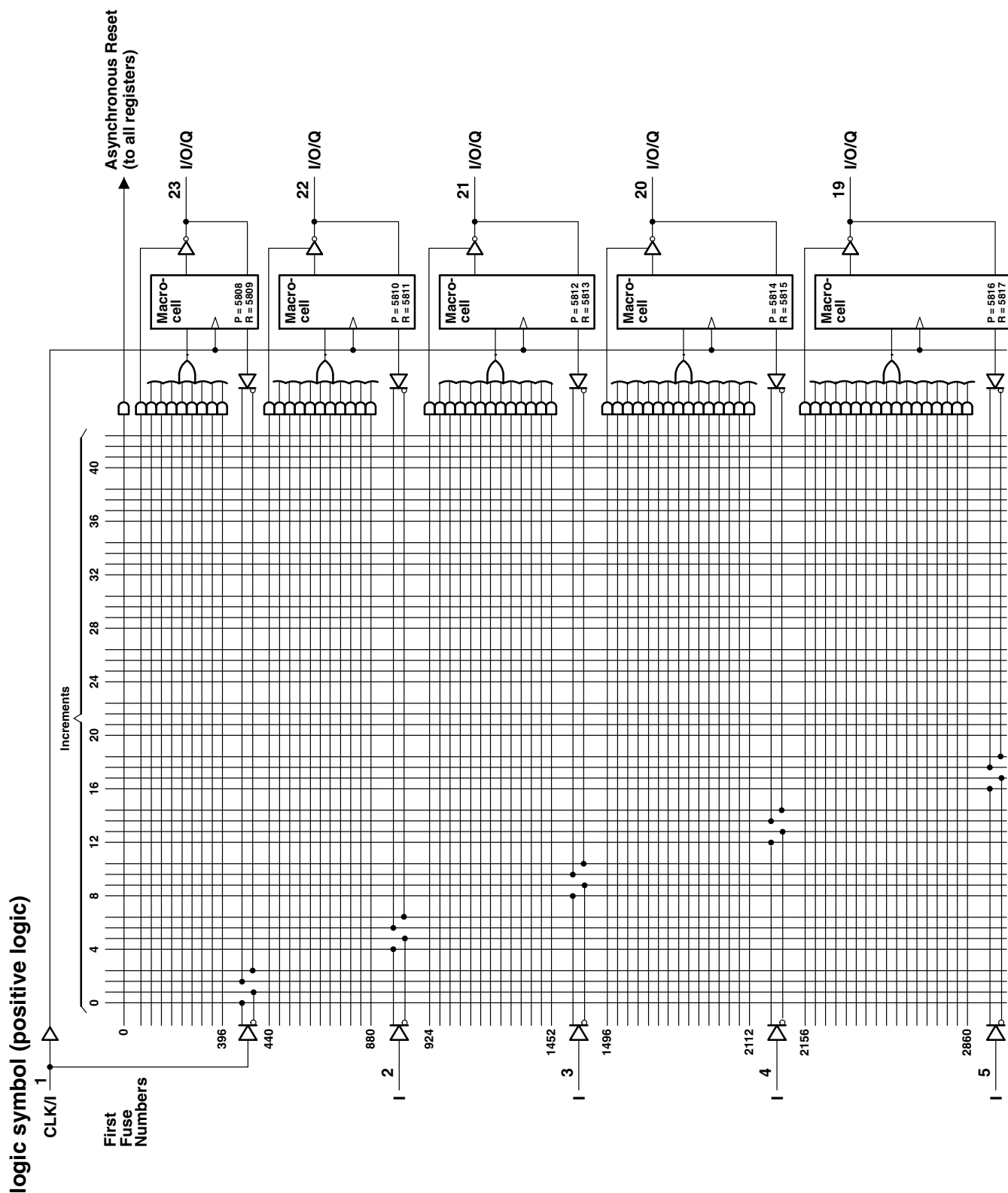
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## functional block diagram (positive logic)



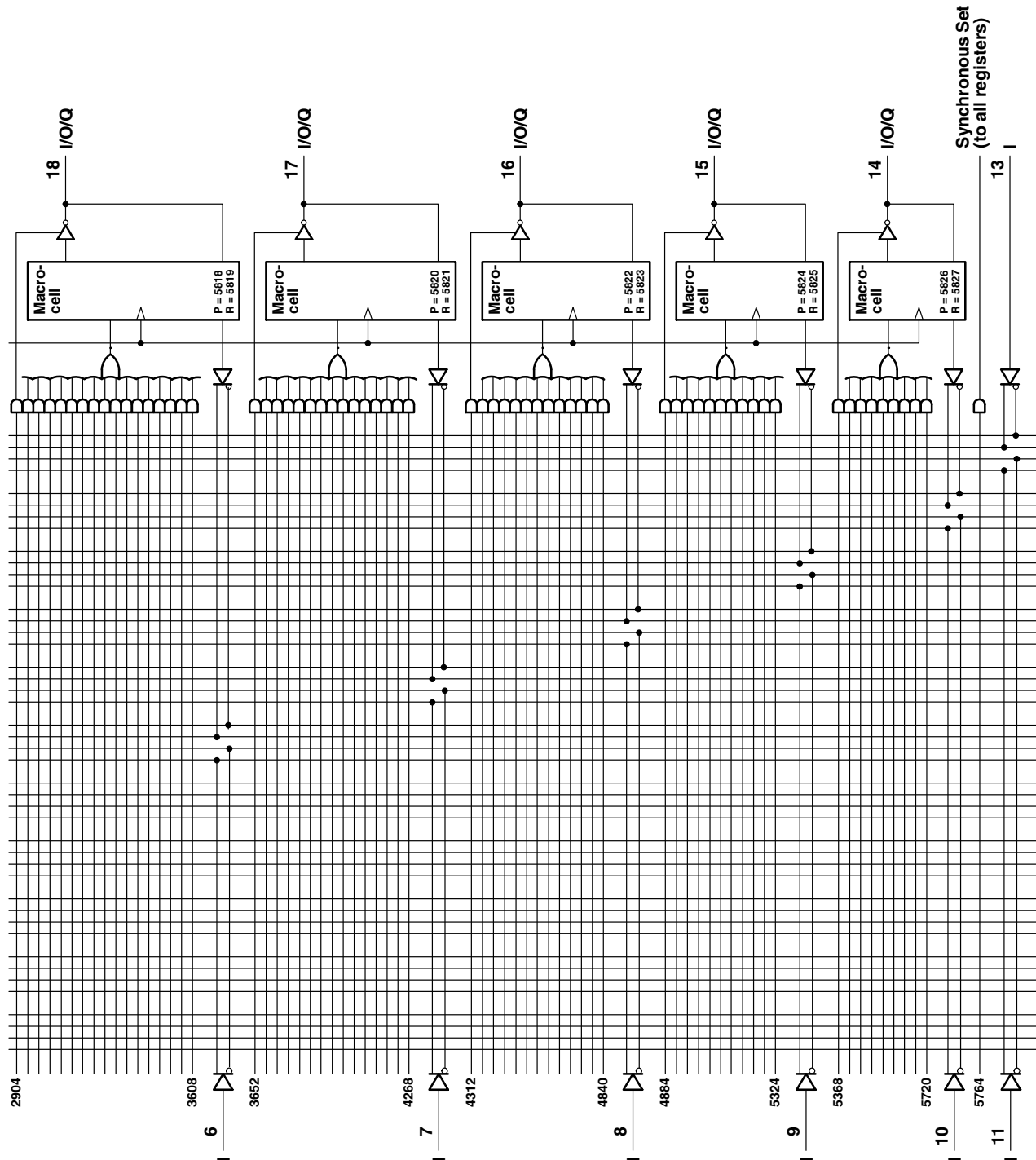
# TIBPAL22V10C, TIBPAL22V10AC, TIBPAL22V10AM HIGH-PERFORMANCE *IMPACT*™ PROGRAMMABLE ARRAY LOGIC CIRCUITS

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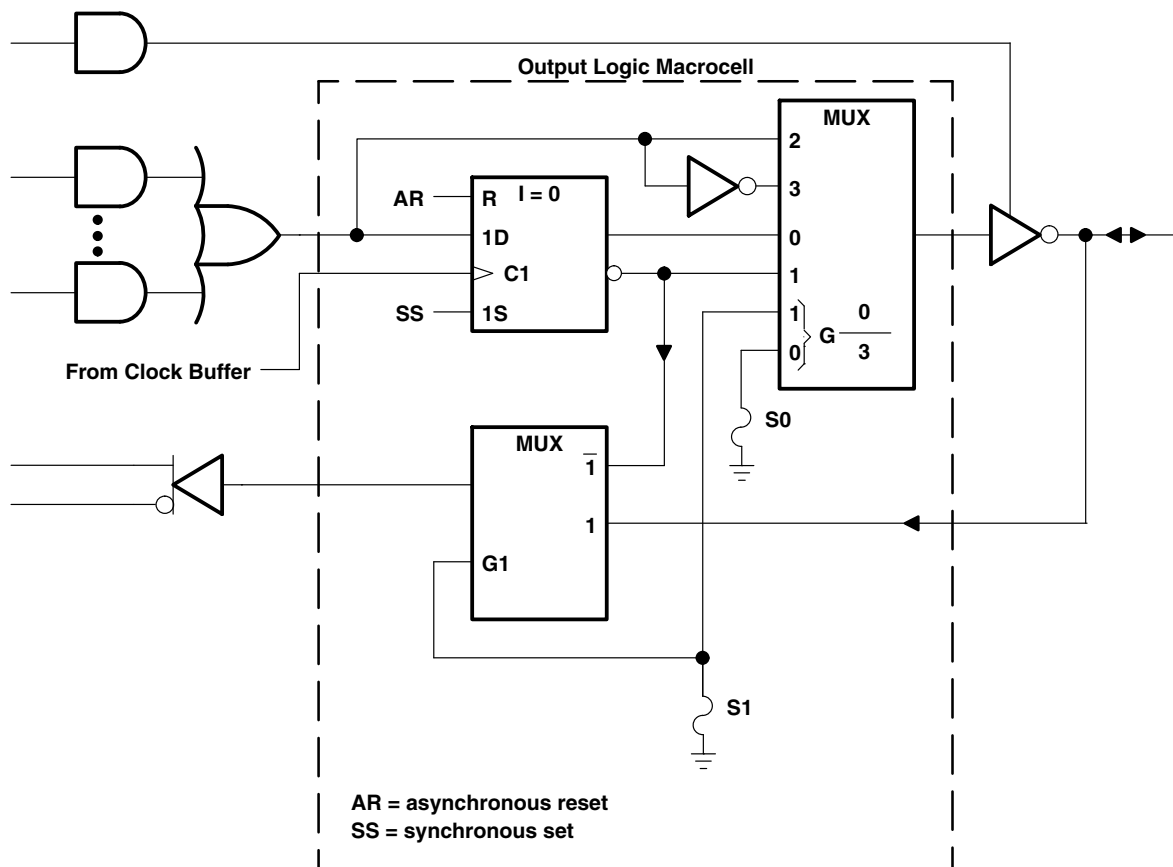
# TIBPAL22V10C, TIBPAL22V10AC, TIBPAL22V10AM HIGH-PERFORMANCE *IMPACT*™ PROGRAMMABLE ARRAY LOGIC CIRCUITS

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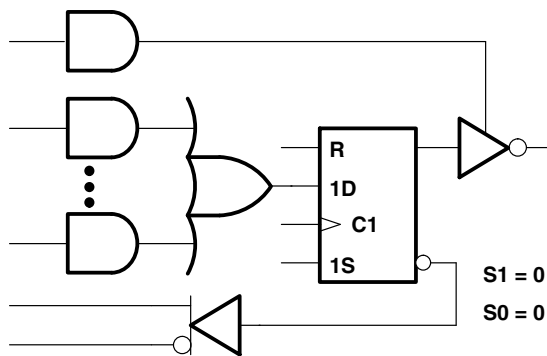
Fuse number = First fuse number + Increment  
Inside each MACROCELL the "P" fuse is the polarity fuse and the "R" fuse is the register fuse.

### output logic macrocell diagram

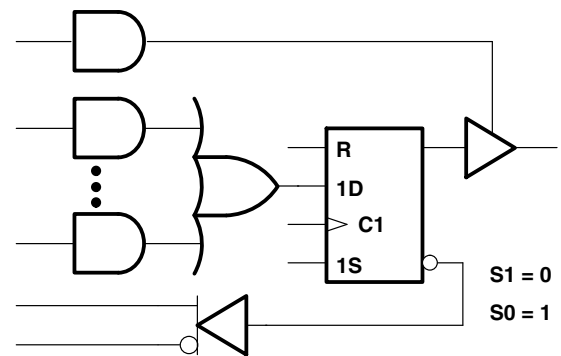


# TIBPAL22V10C, TIBPAL22V10AC, TIBPAL22V10AM HIGH-PERFORMANCE *IMPACT*™ PROGRAMMABLE ARRAY LOGIC CIRCUITS

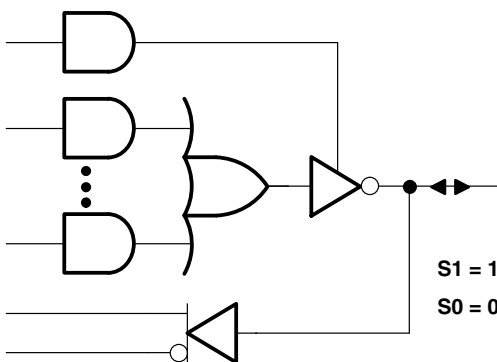
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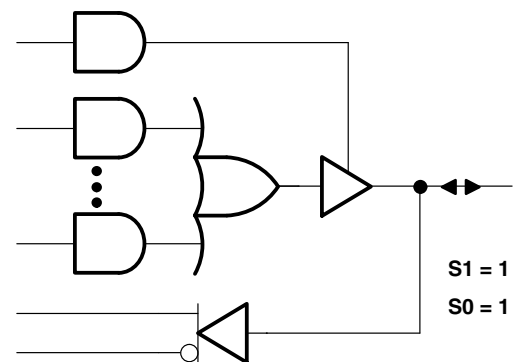
REGISTER FEEDBACK, REGISTERED, ACTIVE-LOW OUTPUT



REGISTER FEEDBACK, REGISTERED, ACTIVE-HIGH OUTPUT



I/O FEEDBACK, COMBINATIONAL, ACTIVE-LOW OUTPUT



I/O FEEDBACK, COMBINATIONAL, ACTIVE-HIGH OUTPUT

MACROCELL FEEDBACK AND OUTPUT FUNCTION TABLE

| FUSE SELECT |    | FEEDBACK AND OUTPUT CONFIGURATION |               |             |
|-------------|----|-----------------------------------|---------------|-------------|
| S1          | S0 |                                   |               |             |
| 0           | 0  | Register feedback                 | Registered    | Active low  |
| 0           | 1  | Register feedback                 | Registered    | Active high |
| 1           | 0  | I/O feedback                      | Combinational | Active low  |
| 1           | 1  | I/O feedback                      | Combinational | Active high |

0 = unblown fuse, 1 = blown fuse

S1 and S0 are select-function fuses as shown in the output logic macrocell diagram.

Figure 1. Resultant Macrocell Feedback and Output Logic After Programming

# TIBPAL22V10C, TIBPAL22V10AC

## HIGH-PERFORMANCE *IMPACT*™ PROGRAMMABLE ARRAY LOGIC CIRCUITS

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### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

|   |                |
|---|----------------|
| Supply voltage, $V_{CC}$ (see Note 1)                 | 7 V            |
| Input voltage (see Note 1)                            | –5.5 V         |
| Voltage range applied to disabled output (see Note 1) | 5.5 V          |
| Operating free-air temperature range                  | 0°C to 75°C    |
| Storage temperature range                             | –65°C to 150°C |

NOTE 1: These ratings apply except for programming pins during a programming cycle or during a preload cycle.

### recommended operating conditions

|                    |   |                                   | TIBPAL22V10C |     |      | TIBPAL22V10AC |     |      | UNIT |     |
|--------------------|---|-----------------------------------|--------------|-----|------|---------------|-----|------|------|-----|
|                    |   |                                   | MIN          | NOM | MAX  | MIN           | NOM | MAX  |      |     |
| V <sub>CC</sub>    | Supply voltage                                  |                                   | 4.75         | 5   | 5.25 | 4.75          | 5   | 5.25 | V    |     |
| V <sub>IH</sub>    | High-level input voltage                        |                                   | 2            |     | 5.5  |               | 2   |      | 5.5  | V   |
| V <sub>IL</sub>    | Low-level input voltage                         |                                   |              |     | 0.8  |               |     |      | 0.8  | V   |
| I <sub>OH</sub>    | High-level output current                       |                                   |              |     | −3.2 |               |     |      | −3.2 | mA  |
| I <sub>OL</sub>    | Low-level output current                        |                                   |              |     | 16   |               |     |      | 16   | mA  |
| f <sub>clock</sub> | Clock frequency†                                |                                   |              |     | 18   |               |     |      | 28.5 | MHz |
| t <sub>w</sub>     | Pulse duration                                  | Clock high or low                 | 25           |     |      | 15            |     |      | ns   |     |
|                    |   | Asynchronous reset high or low    | 35           |     |      | 25            |     |      |      |     |
| t <sub>su</sub>    | Setup time before clock↑                        | Input                             | 30           |     |      | 20            |     |      | ns   |     |
|                    |   | Feedback                          | 30           |     |      | 20            |     |      |      |     |
|                    |   | Synchronous set                   | 30           |     |      | 25            |     |      |      |     |
|                    |   | Asynchronous reset low (inactive) | 35           |     |      | 25            |     |      |      |     |
| t <sub>h</sub>     | Hold time, input, set, or feedback after clock↑ |                                   | 0            |     |      | 0             |     |      | ns   |     |
| T <sub>A</sub>     | Operating free-air temperature                  |                                   | 0            |     |      | 75            |     |      | °C   |     |

$$^\dagger f_{clock} \text{ (with feedback)} = \frac{1}{t_{su} + t_{pd}(\text{CLK to Q})}, f_{clock} \text{ (without feedback)} = \frac{1}{t_w(\text{low}) + t_w(\text{high})}$$



# TIBPAL22V10C, TIBPAL22V10AC

## HIGH-PERFORMANCE *IMPACT*™ PROGRAMMABLE ARRAY LOGIC CIRCUITS

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### electrical characteristics over recommended operating free-air temperature range

| PARAMETER         |            | TEST CONDITIONS  | TIBPAL22V10C |      |       | TIBPAL22V10AC |      |       | UNIT          |
|-------------------|------------|--|--------------|------|-------|---------------|------|-------|---------------|
|                   |            |  | MIN          | TYP† | MAX   | MIN           | TYP† | MAX   |               |
| $V_{IK}$          |            | $V_{CC} = 4.75\text{ V}$ , $I_I = -18\text{ mA}$             |              |      | -1.2  |               |      | -1.2  | V             |
| $V_{OH}$          |            | $V_{CC} = 4.75\text{ V}$ , $I_{OH} = -3.2\text{ mA}$         | 2.4          | 3.5  |       | 2.4           | 3.5  |       | V             |
| $V_{OL}$          |            | $V_{CC} = 4.75\text{ V}$ , $I_{OL} = 16\text{ mA}$           |              | 0.35 | 0.5   |               | 0.35 | 0.5   | V             |
| $I_{OZH}$         |            | $V_{CC} = 5.25\text{ V}$ , $V_O = 2.7\text{ V}$              |              |      | 0.1   |               |      | 0.1   | mA            |
| $I_{IL}$          | Any output | $V_{CC} = 5.25\text{ V}$ , $V_I = 0.4\text{ V}$              |              |      | -100  |               |      | -100  | $\mu\text{A}$ |
|                   | Any I/O    |  |              |      | -250  |               |      | -250  |               |
| $I_I$             |            | $V_{CC} = 5.25\text{ V}$ , $V_I = 5.5\text{ V}$              |              |      | 1     |               |      | 1     | mA            |
| $I_{IH}$          |            | $V_{CC} = 5.25\text{ V}$ , $V_I = 2.7\text{ V}$              |              |      | 25    |               |      | 25    | $\mu\text{A}$ |
| $I_{IL}$          |            | $V_{CC} = 5.25\text{ V}$ , $V_I = 0.4\text{ V}$              |              |      | -0.25 |               |      | -0.25 | mA            |
| $I_{OS}^\ddagger$ |            | $V_{CC} = 5.25\text{ V}$ , $V_O = 0.5\text{ V}$              | -30          |      | -90   | -30           |      | -90   | mA            |
| $I_{CC}$          |            | $V_{CC} = 5.25\text{ V}$ , $V_I = \text{GND}$ , Outputs open | 120          |      | 180   | 120           |      | 180   | mA            |

### switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER                     | FROM<br>(INPUT) | TO<br>(OUTPUT) | TEST CONDITIONS                            | TIBPAL22V10C |      |     | TIBPAL22V10AC |      |     | UNIT |
|-------------------------------|-----------------|----------------|--|--------------|------|-----|---------------|------|-----|------|
|                               |                 |                |  | MIN          | TYP† | MAX | MIN           | TYP† | MAX |      |
| f <sub>max</sub> <sup>¶</sup> | With feedback   |                | R1 = 300 Ω,<br>R2 = 390 Ω,<br>See Figure 4 | 18           |      |     | 28.5          |      |     | MHz  |
| t <sub>pd</sub>               | I, I/O          | I/O            |  | 15    35     |      |     | 15    25      |      |     | ns   |
| t <sub>pd</sub>               | I, I/O (reset)  | Q              |  | 15    40     |      |     | 15    30      |      |     | ns   |
| t <sub>pd</sub>               | CLK             | Q              |  | 10    25     |      |     | 10    15      |      |     | ns   |
| t <sub>en</sub>               | I, I/O          | I/O, Q         |  | 15    35     |      |     | 15    25      |      |     | ns   |
| t <sub>dis</sub>              | I, I/O          | I/O, Q         |  | 15    35     |      |     | 15    25      |      |     | ns   |

† All typical values are at  $V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$ .‡ Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.  $V_O$  is set at 0.5 V to avoid test problems caused by test equipment ground degradation.

$$^{\S} f_{\max} \text{ (with feedback)} = \frac{1}{t_{su} + t_{pd}(\text{CLK to Q})}, f_{\max} \text{ (without feedback)} = \frac{1}{t_{w(\text{low})} + t_{w(\text{high})}}$$

**TIBPAL22V10AM****HIGH-PERFORMANCE *IMPACT*™ PROGRAMMABLE ARRAY LOGIC CIRCUITS**

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**absolute maximum ratings over operating free-air temperature range (unless otherwise noted)**

|   |                |
|---|----------------|
| Supply voltage, $V_{CC}$ (see Note 1)                 | 7 V            |
| Input voltage (see Note 1)                            | –5.5 V         |
| Voltage range applied to disabled output (see Note 1) | 5.5 V          |
| Operating free-air temperature range                  | –55°C to 125°C |
| Storage temperature range                             | –65°C to 150°C |

NOTE 1: These ratings apply except for programming pins during a programming cycle or during a preload cycle.

**recommended operating conditions**

|             |   | MIN                               | NOM | MAX | UNIT |
|-------------|---|-----------------------------------|-----|-----|------|
| $V_{CC}$    | Supply voltage                                  | 4.5                               | 5   | 5.5 | V    |
| $V_{IH}$    | High-level input voltage                        | 2                                 |     | 5.5 | V    |
| $V_{IL}$    | Low-level input voltage                         |                                   |     | 0.8 | V    |
| $I_{OH}$    | High-level output current                       |                                   |     | –2  | mA   |
| $I_{OL}$    | Low-level output current                        |                                   |     | 12  | mA   |
| $f_{clock}$ | Clock frequency†                                |                                   |     | 22  | MHz  |
| $t_w$       | Pulse duration                                  | Clock high or low                 |     | 20  | ns   |
|             |   | Asynchronous reset high or low    |     | 30  |      |
| $t_{su}$    | Setup time before clock↑                        | Input                             |     | 25  | ns   |
|             |   | Feedback                          |     | 25  |      |
|             |   | Synchronous set                   |     | 25  |      |
|             |   | Asynchronous reset low (inactive) |     | 30  |      |
| $t_h$       | Hold time, input, set, or feedback after clock↑ | 0                                 |     |     | ns   |
| $T_A$       | Operating free-air temperature                  | –55                               |     | 125 | °C   |

$$† f_{clock} \text{ (with feedback)} = \frac{1}{t_{su} + t_{pd}(\text{CLK to Q})}, f_{clock} \text{ (without feedback)} = \frac{1}{t_w(\text{low}) + t_w(\text{high})}$$

# TIBPAL22V10AM

## HIGH-PERFORMANCE *IMPACT*™ PROGRAMMABLE ARRAY LOGIC CIRCUITS

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### electrical characteristics over recommended operating free-air temperature range

| PARAMETER         | TEST CONDITIONS           |                                      | MIN | TYP† | MAX   | UNIT |
|-------------------|---------------------------|--------------------------------------|-----|------|-------|------|
| $V_{IK}$          | $V_{CC} = 4.5\text{ V}$ , | $I_I = -18\text{ mA}$                |     |      | -1.2  | V    |
| $V_{OH}$          | $V_{CC} = 4.5\text{ V}$ , | $I_{OH} = -2\text{ mA}$              | 2.4 | 3.5  |       | V    |
| $V_{OL}$          | $V_{CC} = 4.5\text{ V}$ , | $I_{OL} = 12\text{ mA}$              |     | 0.25 | 0.5   | V    |
| $I_{OZH}$         | $V_{CC} = 5.5\text{ V}$ , | $V_O = 2.7\text{ V}$                 |     |      | 0.1   | mA   |
| $I_{OZL}$         | $V_{CC} = 5.5\text{ V}$ , | $V_O = 0.4\text{ V}$                 |     |      | -100  | μA   |
| $I_I$             | $V_{CC} = 5.5\text{ V}$ , | $V_I = 5.5\text{ V}$                 |     |      | 1     | mA   |
| $I_{IH}$          | $V_{CC} = 5.5\text{ V}$ , | $V_I = 2.7\text{ V}$                 |     |      | 25    | μA   |
| $I_{IL}$          | $V_{CC} = 5.5\text{ V}$ , | $V_I = 0.4\text{ V}$                 |     |      | -0.25 | mA   |
| $I_{OS}^\ddagger$ | $V_{CC} = 5.5\text{ V}$ , | $V_O = 0.5\text{ V}$                 | -30 |      | -90   | mA   |
| $I_{CC}$          | $V_{CC} = 5.5\text{ V}$ , | $V_I = \text{GND}$ ,<br>Outputs open |     | 120  | 180   | mA   |

### switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

| PARAMETER       | FROM (INPUT)   | TO (OUTPUT) | TEST CONDITIONS                            | MIN | TYP† | MAX | UNIT |
|-----------------|----------------|-------------|--|-----|------|-----|------|
| $f_{\max}^{\S}$ | With feedback  |             | R1 = 390 Ω,<br>R2 = 750 Ω,<br>See Figure 4 | 22  |      |     | MHz  |
| $t_{pd}$        | I, I/O         | I/O         |  |     | 15   | 30  | ns   |
| $t_{pd}$        | I, I/O (reset) | Q           |  |     | 15   | 35  | ns   |
| $t_{pd}$        | CLK            | Q           |  |     | 10   | 20  | ns   |
| $t_{en}$        | I, I/O         | I/O, Q      |  |     | 15   | 30  | ns   |
| $t_{dis}$       | I, I/O         | I/O, Q      |  |     | 15   | 30  | ns   |

† All typical values are at  $V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$ .‡ Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.  $V_O$  is set at 0.5 V to avoid test problems caused by test equipment ground degradation.

$$^{\S} f_{\max} (\text{with feedback}) = \frac{1}{t_{su} + t_{pd}(\text{CLK to Q})}, \quad f_{\max} (\text{without feedback}) = \frac{1}{t_{w(\text{low})} + t_{w(\text{high})}}$$

# TIBPAL22V10C, TIBPAL22V10AC, TIBPAL22V10AM

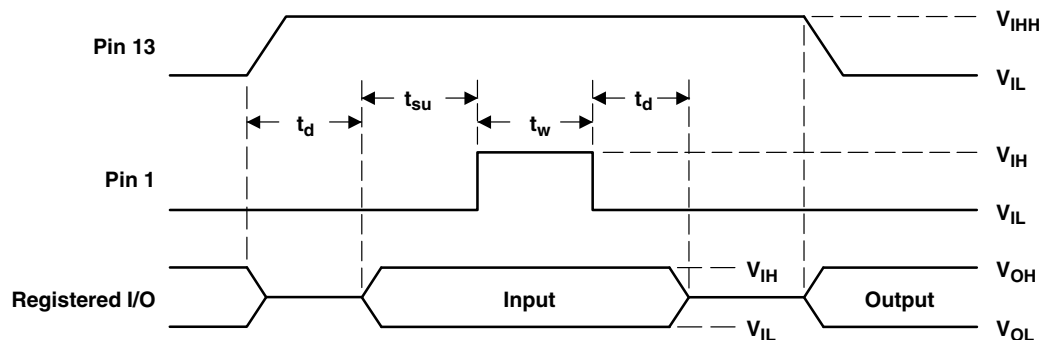
## HIGH-PERFORMANCE *IMPACT*™ PROGRAMMABLE ARRAY LOGIC CIRCUITS

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### preload procedure for registered outputs (see Notes 2 and 3)

The output registers can be preloaded to any desired state during device testing. This permits any state to be tested without having to step through the entire state-machine sequence. Each register is preloaded individually by following the steps given below:

- Step 1. With  $V_{CC}$  at 5 V and pin 1 at  $V_{IL}$ , raise pin 13 to  $V_{IHH}$ .
- Step 2. Apply either  $V_{IL}$  or  $V_{IH}$  to the output corresponding to the register to be preloaded.
- Step 3. Pulse pin 1, clocking in preload data.
- Step 4. Remove output voltage, then lower pin 13 to  $V_{IL}$ . Preload can be verified by observing the voltage level at the output pin.



**Figure 2. Preload Waveforms**

NOTES: 2. Pin numbers shown are for JT and NT packages only. If chip-carrier socket adapter is not used, pin numbers must be changed accordingly.

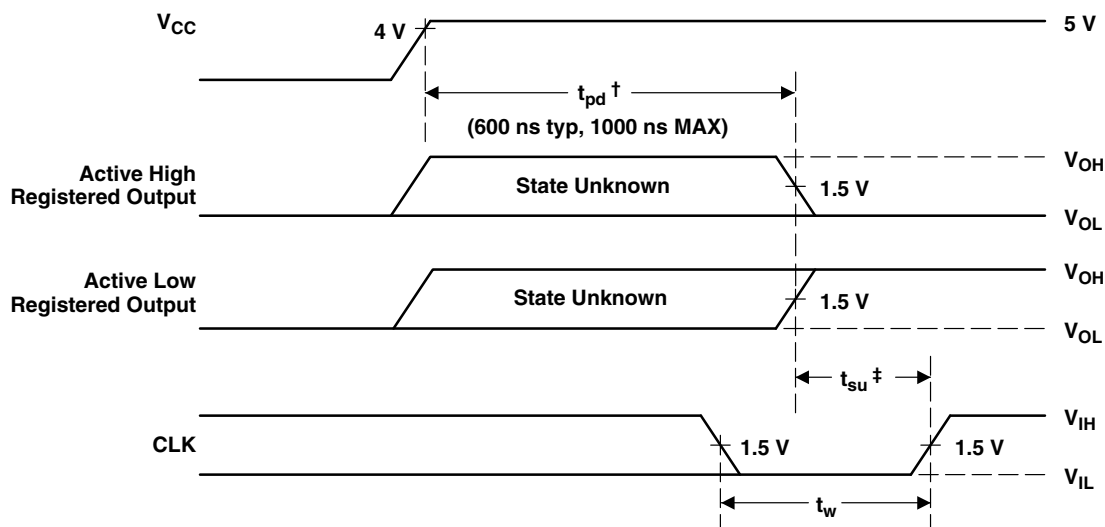
3.  $t_d = t_{su} = t_w = 100 \text{ ns to } 1000 \text{ ns}$ .  $V_{IHH} = 10.25 \text{ V to } 10.75 \text{ V}$ .

# TIBPAL22V10C, TIBPAL22V10AC, TIBPAL22V10AM HIGH-PERFORMANCE *IMPACT*™ PROGRAMMABLE ARRAY LOGIC CIRCUITS

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## power-up reset

Following power up, all registers are reset to zero. The output level depends on the polarity selected during programming. This feature provides extra flexibility to the system designer and is especially valuable in simplifying state-machine initialization. To ensure a valid power-up reset, it is important that the rise of  $V_{CC}$  be monotonic. Following power-up reset, a low-to-high clock transition must not occur until all applicable input and feedback setup times are met.



† This is the power-up reset time and applies to registered outputs only. The values shown are from characterization data.

‡ This is the setup time for input or feedback.

Figure 3. Power-Up Reset Waveforms

## programming information

Texas Instruments programmable logic devices can be programmed using widely available software and inexpensive device programmers.

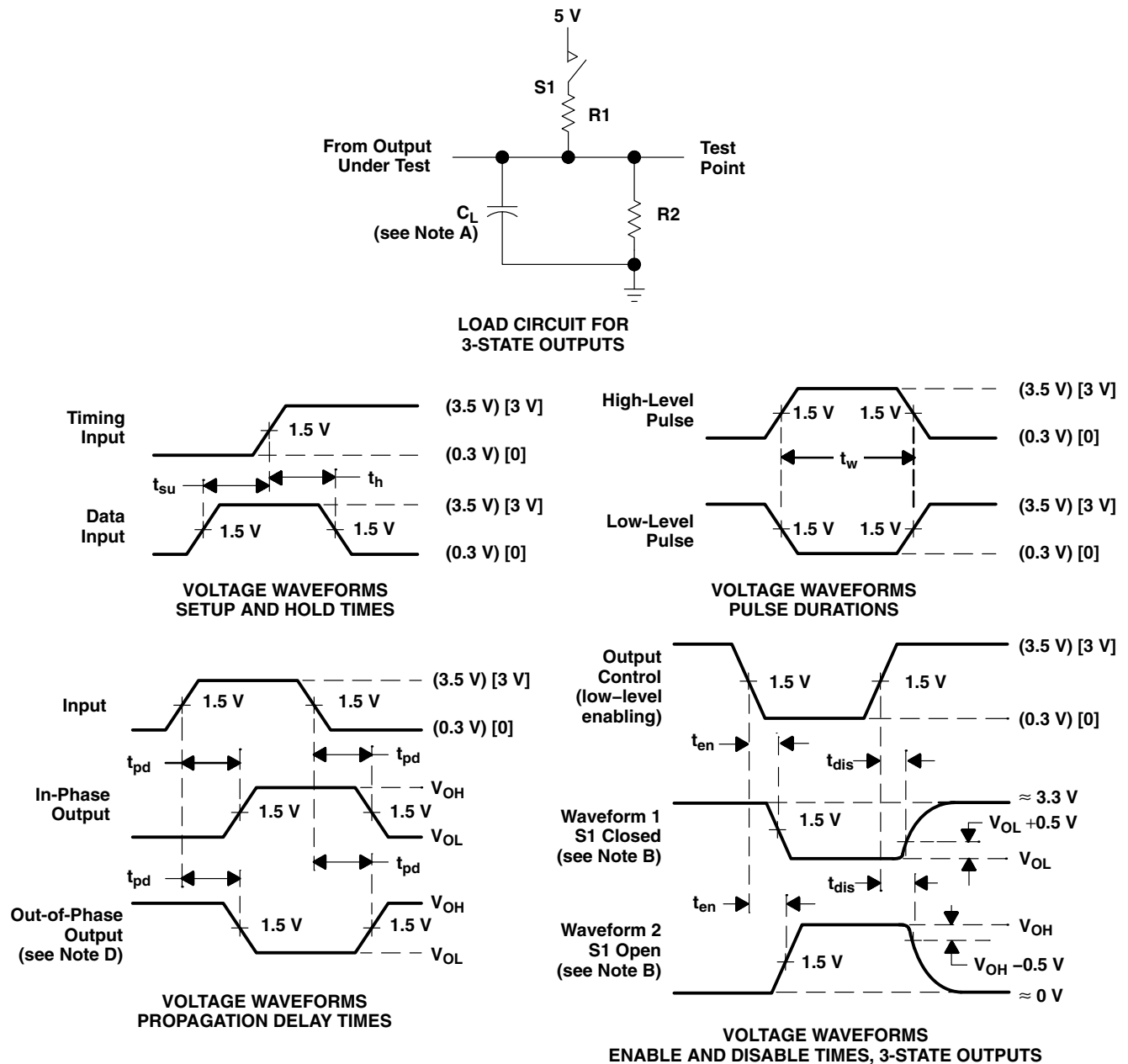
Complete programming specifications, algorithms, and the latest information on hardware, software, and firmware are available upon request. Information on programmers capable of programming Texas Instruments programmable logic is also available, upon request, from the nearest TI field sales office, local authorized TI distributor, or by calling Texas Instruments at (214) 997-5666.

# TIBPAL22V10C, TIBPAL22V10AC, TIBPAL22V10AM

## HIGH-PERFORMANCE *IMPACT*™ PROGRAMMABLE ARRAY LOGIC CIRCUITS

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### PARAMETER MEASUREMENT INFORMATION



NOTES: A.  $C_L$  includes probe and jig capacitance and is 50 pF for  $t_{pd}$  and  $t_{en}$ , 5 pF for  $t_{dis}$ .

B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

C. All input pulses have the following characteristics: For C suffix, use the voltage levels indicated in parentheses ( ).  $PRR \leq 1$  MHz,  $t_r = t_f \leq 2$  ns, duty cycle = 50%. For M suffix, use the voltage levels indicated in brackets [ ].  $PRR \leq 10$  MHz,  $t_r$  and  $t_f \leq 2$  ns, duty cycle = 50%.

D. When measuring propagation delay times of 3-state outputs, switch S1 is closed.

E. Equivalent loads may be used for testing.

Figure 4. Load Circuit and Voltage Waveforms

**PACKAGING INFORMATION**

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2) | Lead/Ball Finish<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5)                    | Samples |
|------------------|---------------|--------------|--------------------|------|----------------|-----------------|-------------------------|----------------------|--------------|--|---------|
| 5962-86053013A   | LIFEBUY       | LCCC         | FK                 | 28   | 1              | TBD             | Call TI                 | Call TI              | -55 to 125   | 5962-<br>86053013A<br>TIBPAL22<br>V10AMFKB |         |
| 5962-8605301KA   | LIFEBUY       | CFP          | W                  | 24   | 1              | TBD             | Call TI                 | Call TI              | -55 to 125   | 5962-8605301KA<br>TIBPAL22V10AMW<br>B      |         |
| 5962-8605301LA   | LIFEBUY       | CDIP         | JT                 | 24   | 1              | TBD             | Call TI                 | Call TI              | -55 to 125   | 5962-8605301LA<br>TIBPAL22V10AMJ<br>TB     |         |
| TIBPAL22V10AMFKB | LIFEBUY       | LCCC         | FK                 | 28   | 1              | TBD             | POST-PLATE              | N / A for Pkg Type   | -55 to 125   | 5962-<br>86053013A<br>TIBPAL22<br>V10AMFKB |         |
| TIBPAL22V10AMJT  | LIFEBUY       | CDIP         | JT                 | 24   | 1              | TBD             | A42                     | N / A for Pkg Type   | -55 to 125   | TIBPAL22V10AMJ<br>T                        |         |
| TIBPAL22V10AMJTB | LIFEBUY       | CDIP         | JT                 | 24   | 1              | TBD             | A42                     | N / A for Pkg Type   | -55 to 125   | 5962-8605301LA<br>TIBPAL22V10AMJ<br>TB     |         |
| TIBPAL22V10AMWB  | LIFEBUY       | CFP          | W                  | 24   | 1              | TBD             | A42                     | N / A for Pkg Type   | -55 to 125   | 5962-8605301KA<br>TIBPAL22V10AMW<br>B      |         |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

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- (3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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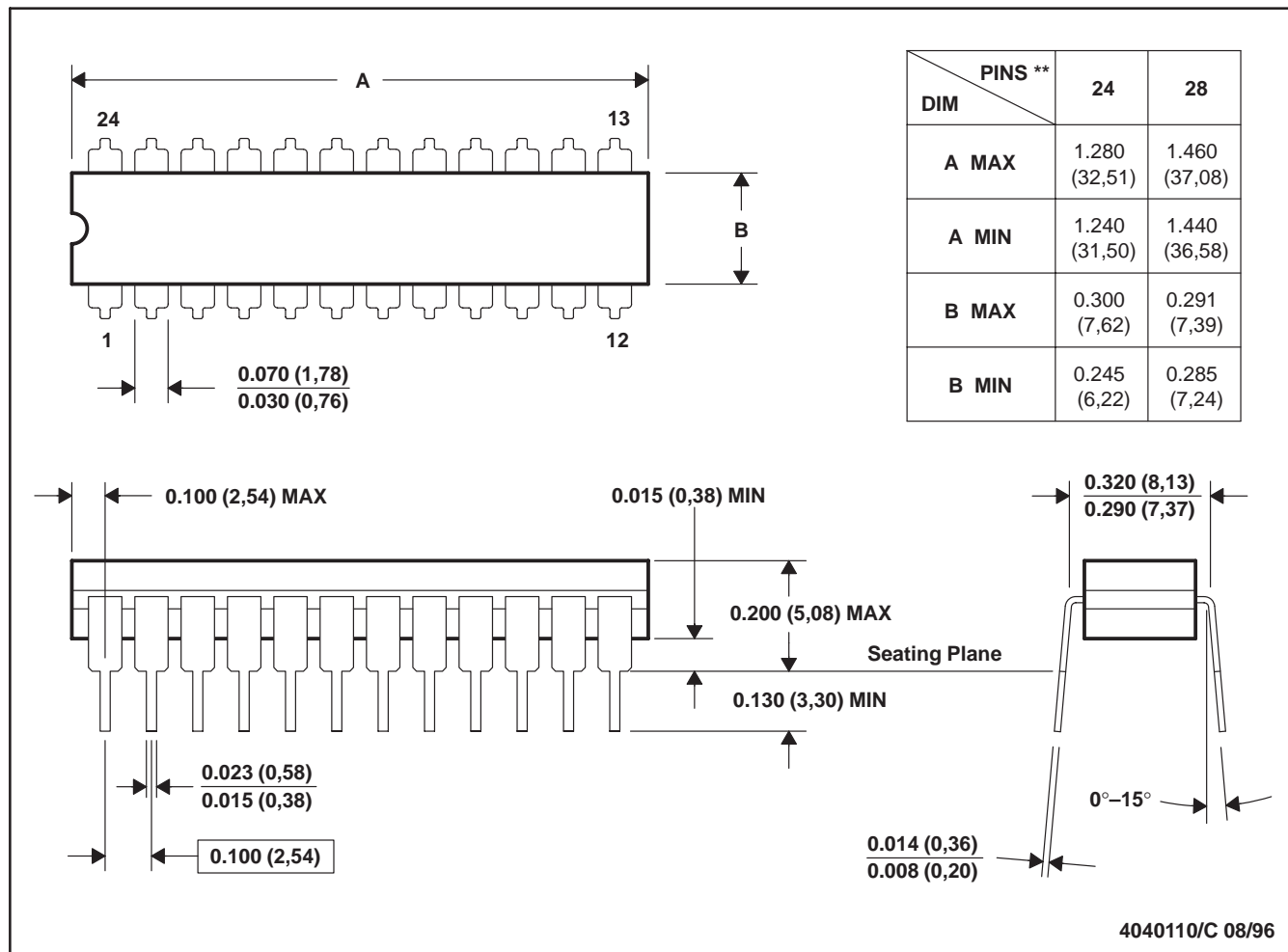
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## JT (R-GDIP-T\*\*)

## CERAMIC DUAL-IN-LINE

24 LEADS SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. This package can be hermetically sealed with a ceramic lid using glass frit.  
 D. Index point is provided on cap for terminal identification.  
 E. Falls within MIL STD 1835 GDIP3-T24, GDIP4-T28, and JEDEC MO-058 AA, MO-058 AB

FK (S-CQCC-N\*\*)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



| NO. OF<br>TERMINALS<br>** | A                |                  | B                |                  |
|---------------------------|------------------|------------------|------------------|------------------|
|                           | MIN              | MAX              | MIN              | MAX              |
| 20                        | 0.342<br>(8,69)  | 0.358<br>(9,09)  | 0.307<br>(7,80)  | 0.358<br>(9,09)  |
| 28                        | 0.442<br>(11,23) | 0.458<br>(11,63) | 0.406<br>(10,31) | 0.458<br>(11,63) |
| 44                        | 0.640<br>(16,26) | 0.660<br>(16,76) | 0.495<br>(12,58) | 0.560<br>(14,22) |
| 52                        | 0.740<br>(18,78) | 0.761<br>(19,32) | 0.495<br>(12,58) | 0.560<br>(14,22) |
| 68                        | 0.938<br>(23,83) | 0.962<br>(24,43) | 0.850<br>(21,6)  | 0.858<br>(21,8)  |
| 84                        | 1.141<br>(28,99) | 1.165<br>(29,59) | 1.047<br>(26,6)  | 1.063<br>(27,0)  |

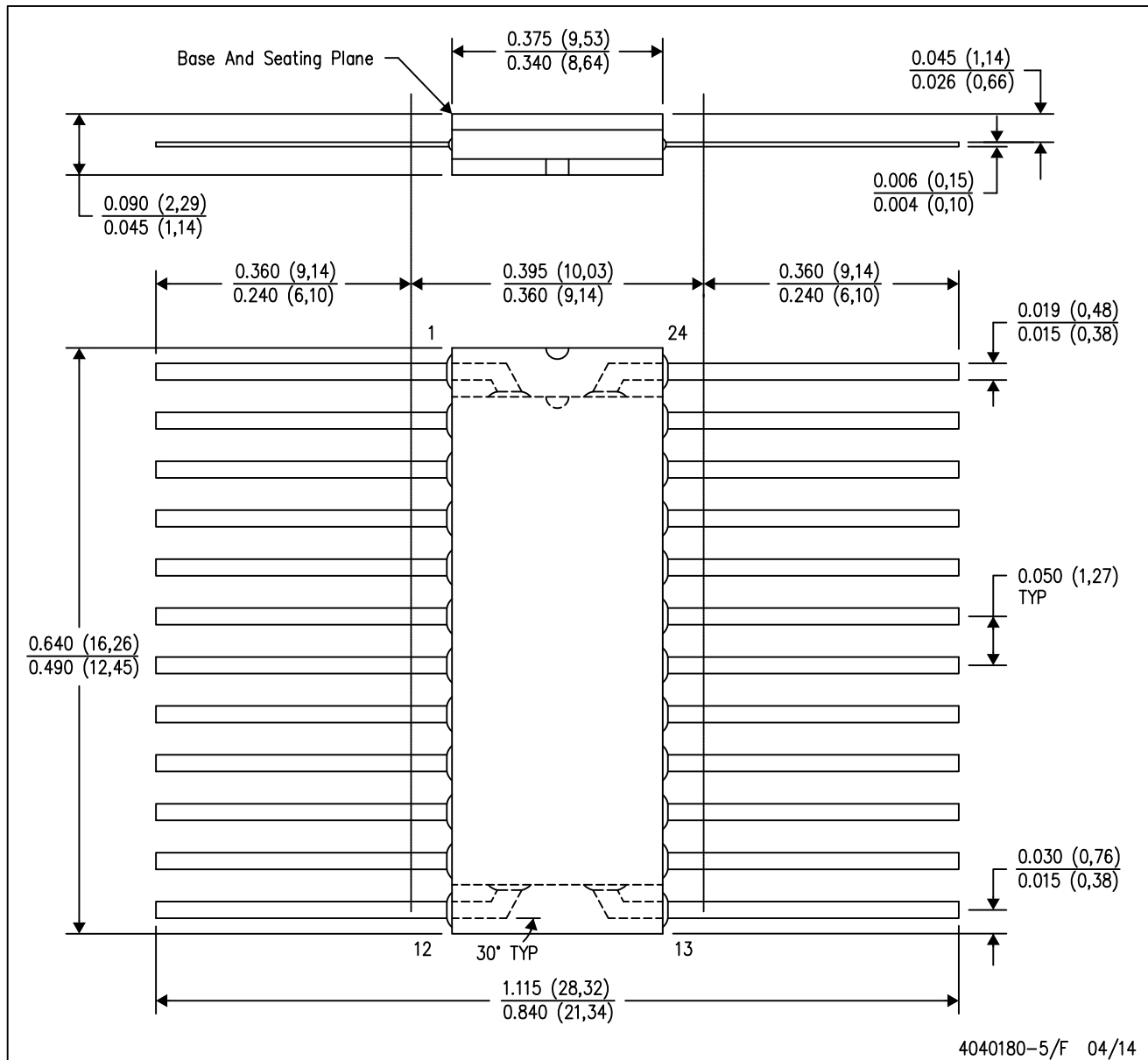


4040140/D 01/11

- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - This package can be hermetically sealed with a metal lid.
  - Falls within JEDEC MS-004

W (R-GDFP-F24)

CERAMIC DUAL FLATPACK



- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - This package can be hermetically sealed with a ceramic lid using glass frit.
  - Index point is provided on cap for terminal identification only.
  - Falls within Mil-Std 1835 GDFP2-F20

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